

Title (en)

Device and method for electrically coupling an electronic circuit in a housing

Title (de)

Anordnung und Verfahren zum elektrischen Anschluss einer elektronischen Schaltung in einem Gehäuse

Title (fr)

Dispositif et méthode pour connecter électriquement un circuit électronique dans un boîtier

Publication

**EP 1734621 B1 20130227 (DE)**

Application

**EP 06113067 A 20060425**

Priority

DE 102005027852 A 20050616

Abstract (en)

[origin: EP1734621A2] The arrangement has a hermetically sealed housing connected with a base plate. Connection units are arranged in a connection section of the plate, and a cover is provided for protection of the section. A line segment comprises a contact section (14) of the conducting paths which are formed on the connection units for formation of an electrical connection. The connection unit is pressed in a recess (17) of the contact section. An independent claim is also included for a method for connecting an electronic circuit in a housing.

IPC 8 full level

**H01R 43/02** (2006.01); **H01R 12/59** (2011.01); **H01R 12/62** (2011.01); **H01R 13/52** (2006.01)

CPC (source: EP)

**H01R 12/592** (2013.01); **H01R 12/62** (2013.01); **H01R 13/5202** (2013.01); **H01R 12/67** (2013.01); **H01R 43/0221** (2013.01)

Cited by

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DE ES FR HU IT

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**EP 06113067 A 20060425**; DE 102005027852 A 20050616; JP 2006165018 A 20060614